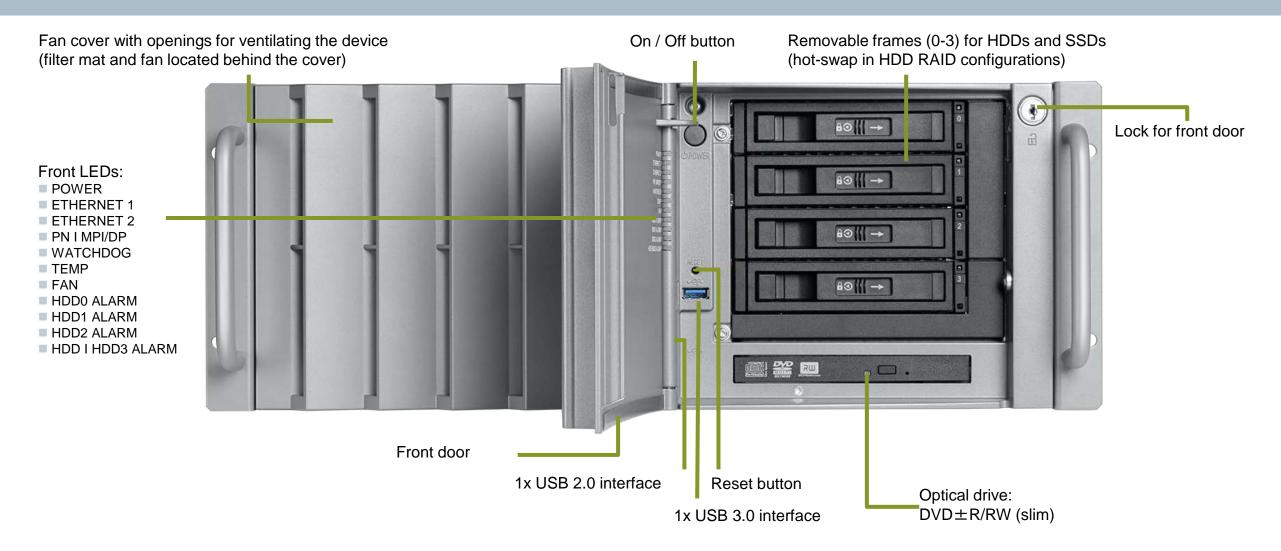


February, 2014

SIMATIC IPC847D Technical Information

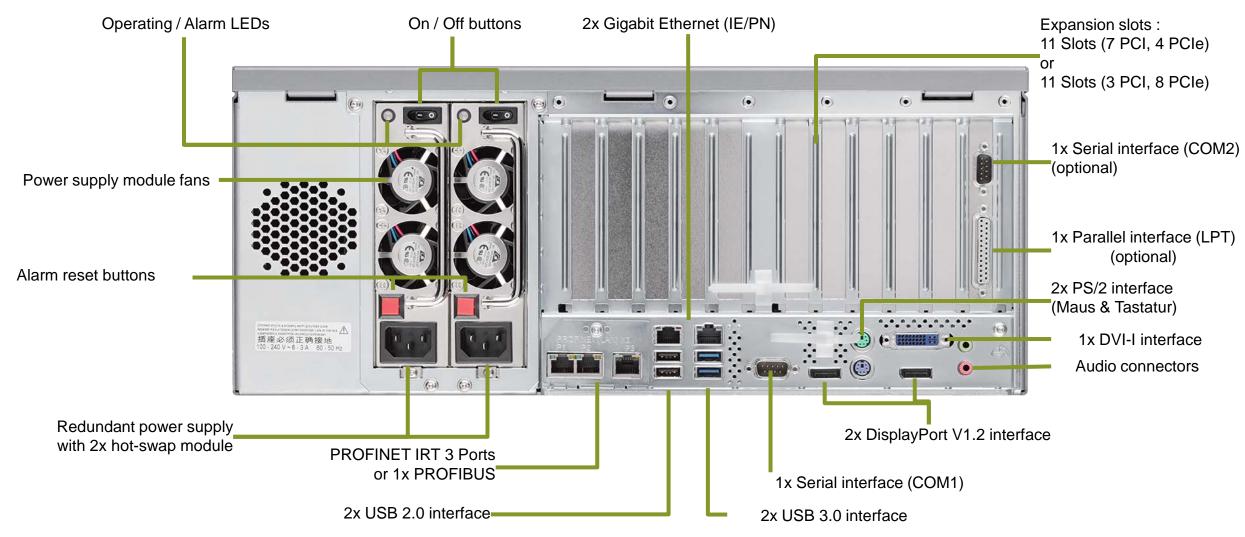
© Siemens AG 2014 All rights reserved.

SIMATIC IPC847D Overview front



[©] Siemens AG 2013 All rights reserved.

SIMATIC IPC847D Overview rear



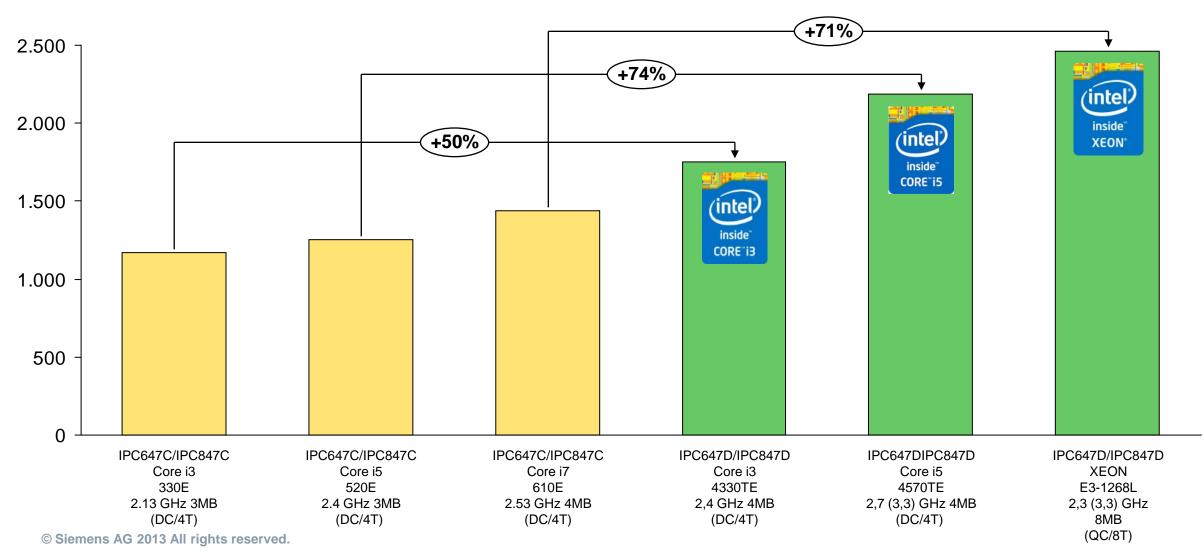
[©] Siemens AG 2013 All rights reserved.

SIMATIC IPC647D / IPC847D Processors characteristics

	Processor name	Processor number	Number of physical cores (Cores)	Number of virtual cores (Threads)	Clock rate / Clock rate with Turbo Boost (GHz)	Cache (MByte)	Turbo Boost 2.0	Virtualization (VT-x / VT-d)	64 Bit (EM64T)	iAMT 9.0	ECC
(intel) inside XEON	Xeon	E3-1268L v3	4	8	2,3 / 3,3	8	✓	√ / √	√	✓	√(*
inside" CORE 15	Core i5	i5- 4570TE	2	4	2,7 / 3,3	4	✓	√ / √	✓	✓	✓
inside" CORE 13	Core i3	i3- 4330TE	2	2	2,4 / -	4	-	√/-	✓	-	✓

The Intel Xeon E3 offers a optimized performance / watt and supports ECC memory – the comparable Intel Core i7 processors do not

Passmark 7 Rating IPC847C vs. IPC847D



Seite 5

Housing, Chipset, Processors, Main Memory, and Expansion Slots				
Housing	 19" Rack, 4U Rugged all-metal housing, painted outside and coated inside Lockable front flap for access protection Prepared for telescopic slides For horizontal and vertical mounting Tower arrangement using tower kit (available as accessory) 			
Chipset	• Intel DH82C226 PCH (C226)			
Processors	 Intel® Xeon™ E3-1268L v3 4C/8T, 2.3 (3.3) GHz, 8 MByte Cache, Turbo Boost 2.0, Virtualization (VT-x/-d)-Technology, iAMT 9.0 Intel® Core™ i5-4570TE 2C/4T, 2.7 (3.3) GHz, 4 MByte Cache, Turbo Boost 2.0, Virtualization (VT-x/-d)-Technology, iAMT 9.0 Intel® Core™ i3-4330TE 2C/4T, 2.4 GHz, 4 MByte Cache, Virtualization (VT-x)-Technology 			
Main Memory	 from 2 GByte DDR3-1600 SDRAM, Dual Channel support, Expandable up to 32 GByte¹⁾ ECC from 8 GByte optional 			
Expansion Slots (all 312 mm)	more PCI-Slots (7 PCI, 4 PCI-Express) • 7 x PCI • 1 x PCI-Express x16 (16 Lane) Gen 3 • 3 x PCI-Express x4 (1 Lane) Gen 2 more PCI-Express Slots (8 PCI-Express, 3 PCI) • 3 x PCI • 1 x PCI-Express x16 (8 Lane) Gen 3 • 2 x PCI-Express x16 (4 Lane) Gen 3 • 2 x PCI-Express x16 (4 Lane) Gen 2 • 3 x PCI-Express x4 (4 Lane) Gen 2			

[©] Siemens AG 2013 All rights reserved.

¹⁾ For configurations up to 4 GByte, the visible memory could be reduced to ca. 3.5 GByte or less (when using 32 bit operating systems).

SIMATIC IPC847D Technical data

Installation Slots and Drives Installation Slots Internal: 2x 3.5" • Front: 3x 5.25" / 4x low-profile removable frame; 1x slim Hard disks Internal installation on the drive carrier plate (HDD) SATA 3.5" • 1x 500 Gbyte HDD (up to 3g/0.3g) • 1x 240 GByte SSD Solid-state drive (SSD) Internal installation in drive holder (shock and vibration-damped) (up to 5g/0.5g) **SATA 2.5**" • 1 x 500 GByte HDD • 1 x 1 TByte HDD • 2 x 1 TByte HDD • RAID1¹⁾, 1 TByte (2x 1 TByte HDD, Mirroring) • RAID1¹⁾, 1 TByte (2x 1 TByte HDD, Mirroring) + 1x 240 GByte SSD⁴⁾ Installation in front drive support in swap frame: • 1x 500 GByte HDD • 1x 1 TByte HDD • 2x 1 TByte HDD • 1x 240 GByte SSD • RAID1^{1) 2)}, 1 TByte (2x 1 TByte HDD, Mirroring) • RAID1^{1) 2)}, 1 TByte (2x 1 TByte HDD, Mirroring) + 1x 1 TByte HDD³⁾ • RAID1^{1) 2)}, 1 TByte (2x 1 TByte HDD, Mirroring) + 1x 240 GByte SSD⁴⁾ 1) RAID controller onboard • RAID5^{1) 2)}, 2 TByte (3x 1 TByte HDD, striping with parity) 2) Hot-swap (if installed in removable frames at the front) 3) Hot spare disk • RAID5¹⁾²⁾, 2 TByte (3x 1 TByte HDD, striping with parity) + 1x 1 TByte HDD³⁾ 4) Operating system if ordered is installed on SSD **Optical Drive** w/o / DVD±R/RW (slim)

[©] Siemens AG 2013 All rights reserved.

Graphics, Power Sup	Graphics, Power Supplies and Operating Systems				
Graphics	 Onboard Intel HD Graphics 4600 integrated in the processor with Dynamic Video Memory with up to 1.7 GByte VGA, DVI and DisplayPort with up to 3840 x 2160 pixels at 60 Hz image refresh rate and 32 bit colors PCI-Express graphics card in PCle x16 slot (as an option) NVIDIA NVS 300 graphics controller with 512 MByte graphics memory Dual Head: 2x VGA or 2x DVI-D with up to 2048 x 1536 pixels at 60 Hz image refresh rate and 32 bit colors 				
Power Supplies	 AC: 100-240 V, 400 W, wide range AC redundant: 2x 100-240 V, 350 W, wide range (as an option) 				
Short-time voltage interruption	• Max. 20 ms				
Operating Systems	 W/o Pre-installed and activated (and enclosed on Restore DVD): Windows 7 Ultimate, MUI¹⁾ (32 / 64 bit), SP 1 Windows Server 2008 R2 incl. 5 clients, MUI¹⁾ (64 bit), SP 1 				

¹⁾ Multi Language User Interface, 5 languages: English, German, French, Spanish, Italian

Interfaces			
Ethernet	 2x Gigabit Ethernet (IE/PN), RJ 45, teaming capable Intel Ethernet Controller WGi217LM und WGi210IT Wake on LAN (WoL) support 		
PROFIBUS DP/MPI	• 12 Mbit/s, isolated, compatible with CP 5622, (optional)		
PROFINET	10/100 Mbit/s with integral 3-port switch, CP1616-compatible (optional)		
DisplayPort	• 2x (V1.2)		
DVI-I	• 1x		
VGA	Via cable adapter (as an option)		
USB 3.0 (high current)	 Front: 1x Rear: 2x Internal: 1x 		
USB 2.0 (high current)	 Front: 1x Rear: 2x 		
Serial	 1x COM1 (V.24) 1x COM2 (V.24) (as an option) 		
Parallel	1x LPT (EPP/ECP) (as an option)		
PS/2	2x (Keyboard, Mouse)		
Audio	1x Line Out, 1x Micro		

[©] Siemens AG 2013 All rights reserved.

SIMATIC IPC847D Technical data

Electromagnetic Compatibility (EMC)

Noise emissions	 EN 61000-6-3, EN 61000-6-4 EN 61000-3-2 Class D; EN 61000-3-3 CISPR 22 EN 55022 Class B FCC Class A
Immunity against conducted interference on the supply lines	 ± 2 kV; according to IEC 61000-4-4; Burst ± 1 kV; according to IEC 61000-4-5; Surge symm. ± 2 kV; according to IEC 61000-4-5; Surge asymm.
Noise immunity on signal lines	 ± 2 kV; according to IEC 61000-4-4; Burst, length > 30 m ± 1 kV; according to IEC 61000-4-4; Burst, length < 30 m ± 2 kV, according to IEC 61000-4-5; Surge, length > 30 m
Immunity against discharge of static electricity	 ± 6 kV contact discharge; according to IEC 61000-4-2 ± 8 kV discharge to air; according to IEC 61000-4-2
Immunity against high- frequency radiation	 10 V/m, 80 MHz to 1 GHz, 80% AM; according to IEC 61000-4-3 3 V/m, 1.4 to 2 GHz, 80% AM; according to IEC 61000-4-3 10 V, 150 kHz to 80 MHz; according to IEC 61000-4-6
Immunity against magnetic fields	• 100 A/m, 50/60 Hz; according to IEC 61000-4-8

[©] Siemens AG 2013 All rights reserved.

System-tested SIMATIC Software, Approvals, Dimensions and Weight				
SIMATIC Software	 STEP 7 WinAC WinCC SOFTNET 			
Safety regulations	 IEC60950-1 EN60950-1 UL60950-1 CSA C22.2 No. 60950-1-07 			
Approvals	 CE cULus (UL 60950) KC C-Tick 			
CE Mark	Operation in residential, office, and industrial areas Interference emission: EN 61000-6-3:2007 + A1:2011 Noise immunity: EN 61000-6-2:2005			
EU Directives	• RoHS			
Installation dimensions	430 mm x 177 mm x 444 mm (W x H x D)			
Weight	From 16 kg			

[©] Siemens AG 2013 All rights reserved.

SIMATIC IPC647D / IPC847D Turbo Boost 2.0 (Xeon)

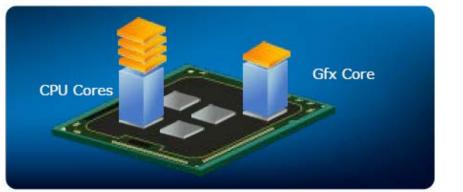
Depending on the CPU core utilization and the temperature levels (TDP and ambient temperature), CPUs which support Turbo Boost technology automatically increase the clock frequency of CPU cores in steps of 133 MHz (bins). Additionally the graphics frequency increases.

The Intel Xeon Processor E3-1268L v3 offers these Turbo Boost values

Processor frequency:
2.3 GHz Max. frequency (Turbo):
3.3 GHz

Graphics frequency: 350 MHz Max. frequency (Turbo): 1000 MHz

Burst Mode: Increased over clocking of the cores by utilizing the thermal budget (TDP) of the CPU for a short time





CPU Turbo bins & Graphics Dynamic Frequency (with Dynamic Range)



Base Frequencies



Idle mode

SIMATIC IPC847D RAID1 vs. RAID5: Overview

RAID 1: Data mirroring

Process

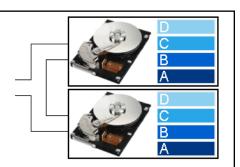
Data is being duplicated and written in parallel on two HDDs

Advantages

- Same data set is secured automatically
- If one HDD fails, the system is still working
 → No data is lost
- → Simple data recovery

Disadvantage

Only the capacity of one HDD can be effectively used



RAID 5: Data striping with parity

Process

Data is being written block by block (striping) on all HDDs (with check sums on all HDDs)

Advantages

- Very efficient with small data blocks
- High data transfer rates when reading
- If one HDD fails, the system is still working
 - → No data is lost
- → Cost-effective possibility for redundant data storage on several HDDs with the available memory volume efficiently used

Disadvantages

- At least three HDDs are required
- Slower data transfer rates when writing compared to RAID1 as the error correction data (parity bits) has to be calculated

NEW: Additional HDD as hot spare in RAID configurations

Process

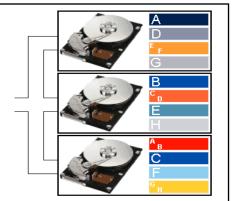
Hot spare disks are preparatory HDDs that are kept on active standby for use when a HDD in a RAID configuration fails

Advantages

- Automatic integration of the hot spare disk into the RAID configuration and start of the rebuild process in case of failure of a contained HDD
- → Maximum data availability

© Siemens AG 2013 All rights reserved.







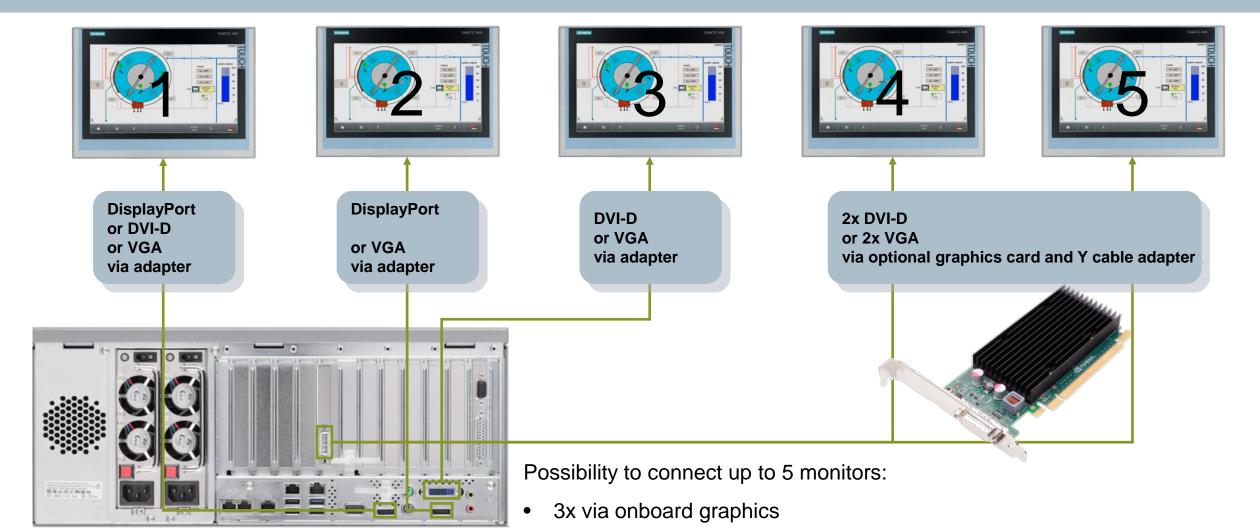
SIMATIC IPC847D RAID1 vs. RAID5: Feature comparison

RAID features	RAID1 (Mirroring)	RAID5 (Striping with parity)	
Minimum amount of HDDs	2 (2x 1 TByte)	3 (3x 1 TByte)	
Data security	Failure of one HDD	Failure of one HDD	
Read performance	Medium	High	
Write performance	Medium	Low	
Capacity utilization of HDDs	50% (1 TByte)	67% - 94% (2 TByte)	
Benefits	High data availability in case of a single HDD failure	Optimal utilization of the used HDD capacity with high fault tolerance	
Typical applications	Real-time critical applications, e.g. databases	Storage of large data volumes, e.g. archiving	

[©] Siemens AG 2013 All rights reserved.



SIMATIC IPC647D / IPC847D Multi-Monitoring (Intel Hybrid Multi-Monitor Support)



[©] Siemens AG 2013 All rights reserved.

2x via graphics card (as an option)

SIMATIC IPC847D Graphics card

NVIDIA Quadro NVS 300 graphics card

NVIDIA Quadro graphics processor: 16 CUDA parallel computing cores¹⁾

Overall frame buffer: 512 MByte

Width of the memory interface: 64 bit

Memory bandwidth: 12.6 Gbit/s
Max. digital monitor resolution at 60 Hz: 2560 x 1600

Graphics slot: PCI-Express x16

Form factor: 69.37 mm x 167.64 mm (ATX bracket, 1 slot)

Interfaces: 2x DVI-D or 2x VGA

Max. power: 17 W
Cooling: Fanless

Scope of supply in configurator: DMS-59 to DVI-D adapter

or DVI to VGA adapter

API: OpenGL 3.3

DirectX 10.1

Shader Model 4.1

¹⁾ CUDA, the parallel calculation architecture from NVIDIA, enables a significant increase in computing performance, using the performance of the graphics processor.





SIMATIC IPC847 Migration C→D

IPC847C		IPC847D		
Installation compatibility				
Housing measures	No changes	V		
Housing design	No major changes	V		
Interface compatibility				
Number of expansion slots	No changes			
Type of expansion slots	1x PCle x16 Gen 3 instead of 1x PCle x16 Gen 2			
Installation slots front	 3x 5.25" / 4x low-profile removable frame instead of 2x 5.25" / 3x low-profile removable frame 1x 5.25" (slim) for DVD±R/RW instead of 1x 5.25" for DVD-ROM / DVD±R/RW & 1x 3.5" 			
External interfaces	 2x DisplayPort V1.2 and DVI-I <u>instead of</u> 1x DVI-I 4x USB 3.0 & 3x USB 2.0 <u>instead of</u> 7x USB 2.0 COM2 & LPT as Slot (option) <u>instead COM2</u> & LPT onboard 			
Software compatibility				
Software	Applications can still be used; maybe new drivers need to be loaded			
Operating system support	Windows XP 7 / Windows Server 2003 R2 (32 bit) / Windows Server 2008 (32 bit) not available anymore			
Miscellaneous compatibility	y y			
Image	New chipset, therefore not image compatible			

[©] Siemens AG 2013 All rights reserved.

SIMATIC IPC847D Order information



Body-MLFB	6AG4114-2	
Ordering system	A&D Mall:Online configurator:Excel configurator:	http://www.siemens.de/automation/mall http://www.siemens.com/ipc-configurator http://intra1.nbgm.siemens.de/pcconfig
Support	Presales:Aftersales:	presales-ipc.i-ia@siemens.com http://www.siemens.com/asis http://www.siemens.com/automation/support-request

© Siemens AG 2013 All rights reserved.